



Spatial Resolution of Crystal Based Hard X-ray Imager

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Inorganic Scintillator-Based Imager for GHz Hard X-ray Imaging



Requirements:	Fast inter-frame & hard x-ray require ultrafast sensor in bulk						
Performance	Type I imager	Type II imager					
X-ray energy	up to 30 keV	42-126 keV					
Frame-rate/inter-frame time	0.5 GHz / 2 ns	3 GHz / 300 ps					
Number of frames per burst	≥ 10	10 - 30					
X-ray detection efficiency	above 50%	above 80%					
Pixel size/pitch	≤ 300 μm	< 300 μm					
Dynamic range	10 ³ X-ray	≥ 10 ⁴ X-ray					
	Photons/pixel/frame	Photons/pixel/frame					
Pixel format	64 × 64 ^a (scalable to 1 Mpix)	1 Mpix					

- With 0.5 ns decay time BaF₂ provides high light output in the 1st ns and a good efficiency for hard X-rays from 30 to 126 keV.
- Yttrium doping in BaF₂ suppresses its slow scintillation significantly and maintains its ultrafast scintillation light.
- A total absorption front imager:
 - Pixelated ultrafast crystal screen;
 - Pixelated ultrafast photodetector;
 - Ultrafast electronics readout.
- This paper discusses spatial resolution for such imager.





12 Fast Scintillators Tested at APS



	BaF ₂	BaF ₂ (:Y)	ZnO (:Ga)	YAP (:Yb)	YAG (:Yb)	β- Ga₂O₃	LYSO (:Ce)	LuAG (:Ce)	YAP (:Ce)	GAGG (:Ce)	LuYAP (:Ce)	YSO (:Ce)
Density (g/cm ³)	4.89	4.89	5.67	5.35	4.56	5.94 ^[1]	7.4	6.76	5.35	6.5	7.2 ^f	4.44
Melting points (°C)	1280	1280	1975	1870	1940	1725	2050	2060	1870	1850	1930	2070
X _o (cm)	2.03	2.03	2.51	2.77	3.53	2.51	1.14	1.45	2.77	1.63	1.37	3.10
R _M (cm)	3.1	3.1	2.28	2.4	2.76	2.20	2.07	2.15	2.4	2.20	2.01	2.93
λ _ι (cm)	30.7	30.7	22.2	22.4	25.2	20.9	20.9	20.6	22.4	21.5	19.5	27.8
Z _{eff}	51.6	51.6	27.7	31.9	30	28.1	64.8	60.3	31.9	51.8	58.6	33.3
dE/dX (MeV/cm)	6.52	6.52	8.42	8.05	7.01	8.82	9.55	9.22	8.05	8.96	9.82	6.57
λ _{peak} ª (nm)	300 220	300 220	380	350	350	380	420	520	370	540	385	420
Refractive Index ^b	1.50	1.50	2.1	1.96	1.87	1.97	1.82	1.84	1.96	1.92	1.94	1.78
Normalized Light Yield ^{a,c}	42 4.8	1.7 4.8	6.6 ^d	0.19 ^d	0.36 ^d	6.5 0.5	100	35° 48°	9 32	115	16 15	80
Total Light yield (ph/MeV)	13,000	2,000	2,000 ^d	57 ^d	110 ^d	2,100	30,000	25,000°	12,000	34,400	10,000	24,000
Decay time ^a (ns)	600 <mark>0.5</mark>	600 <mark>0.5</mark>	<1	1.5	4	148 <mark>6</mark>	40	820 50	191 25	53	1485 36	75
LY in 1 st ns (photons/MeV)	1200	1200	610 ^d	28 ^d	24 ^d	43	740	240	391	640	125	318
40 keV Att. Leng. (1/e, mm)	0.106	0.106	0.407	0.314	0.439	0.394	0.185	0.251	0.314	0.319	0.214	0.334

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X-ray Attenuation Length in Crystals



Five $\lambda @ 100$ keV: 5 and 2 mm for BaF₂ and LYSO, respectively



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BaF₂ Pulses in Lab and APS

3.1& 0.92 ns pulse width measured by PMT (top) & MCP-PMT (bottom) with a decay time of 0.52 ns. 5 mm BaF_2 plates resolve well 30 keV X-ray septuplets of 27 ps width with 2.83 ns spacing at APS (right), demonstrating GHz capability.





X-ray Imaging with CCD Cameras



Spatial resolution of pixelated and monolithic crystal screens measured by PCO & Princeton CCD cameras for ~8 keV X-rays from an AmpTek ECLIPSE-III tube

Light tight and X-ray shielding box





Pixelated Crystal Screens











SIC LYSO:Ce

Tianle LYSO:Ce

BGRI BaF₂

SIC BaF₂:Y

Crystal	Dimension (mm³)	Pitch (mm)	Gap (mm)	Depth (mm)	Reflector	# of Wrapped faces	Vendor	# of λ (40 keV X-ray)	# of samples
LYSO:Ce	20×20×1	0.40	0.12	0.7	TiO ₂	4	SIC	5.4	2
LYSO:Ce	20×20×1	0.828	0.08	1	ESR	4	Tianle	5.4	6
BaF ₂	20×20×5	0.98	0.18	4	TiO ₂	5	BGRI	47.2	1
BaF ₂ :Y	20×20×5	0.98	0.18	4.5	BaSO ₄	4	SIC	47.2	1

Screens with a pitch down to 300 μ m produced by mechanical slicing Laser dicing may reach down to 25 μ m: See US patent US6087618A

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Pixelated LYSO and BaF₂ Screens



SIC and BGRI crystal screens are not cut-through





X-ray Imaging by PCO Camera (I)



Spatial resolution and dynamic range defined by crystal pitch and thickness, respectively





X-ray Imaging by PCO Camera (II)



SIC LYSO with 400 µ pitch







BGRI BaF₂ with 980 μ pitch







CIT Phantom



Resolution of 25 µ may be reached by crystal screens with laser dicing



Monolithic Crystal Screens









SIC LYSO:Ce

BGRI BaF₂

SIC BaF₂:Y

Crystal	Dimension (mm³)	Producer	# of λ (40 keV X-ray)	Amount
LYSO:Ce	10×10×3	SIC	16.2	1
LYSO:Ce	10×10×5	SIC	27.0	1
BaF ₂	20×20×1	BGRI	9.4	1
BaF ₂	20×20×5	BGRI	47.2	1
BaF ₂ :Y	20×20×1.5	SIC	14.1	1
BaF ₂ :Y	13×13×3	SIC	28.3	1
BaF ₂ :Y	13×13×5	SIC	47.2	1



Line-Pair Pattern Phantom and Modulation Transfer Function (MTF)





Object Image Representative Lens/ Lens Assenbly White White 20% Contrast 100% Contrast Black Black LP/mm 1.5 TYPE X-ray imaging line-pair pattern

The MTF value is defined as an average of 8 values for 5 peaks and 4 valleys







Spatial Resolution vs. Screen Thickness and Optical Aperture

Spatial resolution degrades for thicker BaF₂:Y crystal screens Better spatial resolution obtained by using smaller aperture





Summary



GHz hard X-ray imaging presents an unprecedented challenge to timing and spatial resolutions for inorganic scintillator-based front imager.

Beam test with 30 keV X-rays from APS show that 5 mm BaF_2 plates resolve well 30 keV X-ray septuplets of 27 ps width and 2.83 ns spacing.

Pixelated BaF_2 , BaF_2 : Y and LYSO crystal screens with a pitch down to 300 µm may be fabricated by mechanic slicing. Their spatial resolution and detection efficiency for hard X-rays are defined by the pitch and thickness, respectively.

Thicker monolithic crystal screens show poorer spatial resolution, which may be improved by using smaller optical aperture with a loss in both efficiency and dynamic range for hard X-rays.

Plan to pursue pixelated crystal screens with a pitch down to 25 µm by laser slicing. Additional ultrafast inorganic scintillators considered are ZnO:Ga films and all inorganic Cs Pb halide perovskite QD etc.



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Specifications: UV CCD Cameras



UV CCD camera are used to determine spatial resolution

Company	Model	Pixel size (μm)	Pixel Number	QE @ 220 nm	QE @ 420 nm	Frame rate (fps)	Exposure Time	External Trigger	Full Scale (e)	Noise (rms, e)
Hamamatsu	C8000-30	14	640×480	0.70	0.65	31.4	30.8ms-1s	CMOS	30000	150
Hamamatsu	C9100-23B	16	640×480	~0.4	0.65	70.4	1µs-1s	CMOS	140000	8
Princeton Instruments	KURO1020B	11	1200×1200	~0.50	0.75	41	5ms-10s	TTL	80000	typ. 1.3
Intevac Photonics	MicroVista UV	10.8	1280×1024	~0.35	~0.75	30	30µs-260ms	N/A	35000	<50
РСО	pco.edge 4.2 bi UV	6.5	2048×2048	~0.50	~0.70	40	10µs-20s	TTL	48000	typ. 1.9
EHD Imaging	SCM2020-UV	6.5	2048×2048	~0.31	~0.70	45	0.1ms-1000s	TTL	54000	<2
Amsterdam Scientific Instruments	TPX3Cam	55	256×256	0	>0.3	>1M	?	Yes	1000ph	?

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Bar pattern, Sine pattern,

Amplitude

% 10 10

10



X-ray Imaging: effect of thickness and aperture



A better spatial resolution may be obtained by a smaller aperture

SIC LYSO of 20×20×1 mm³

PCO.edge 4.2 bi camera + knife edge method



SIC LYSO of 20×20×0.1 mm³

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